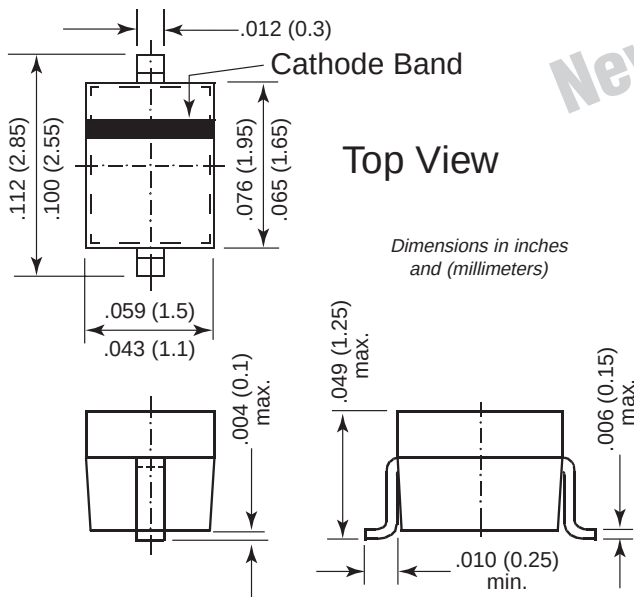
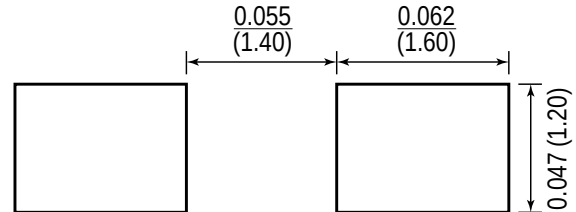



SOD-323

Pad Layout SOD-323


Mechanical Data

Case: SOD-323 plastic package

Weight: approximately 0.004g

Marking Code: SD

Packaging Codes/Options:

D5/10K per 13" reel (8mm tape)

D6/3K per 7" reel (8mm tape)

Features

- Low turn-on voltage
- Fast switching
- Microminiature plastic package
- This device is protected by a PN junction guard ring against excessive voltage, such as electrostatic discharge.
- Ideal for protection of MOS devices, steering, biasing, and coupling diodes for fast switching and low logic level applications.

Maximum Ratings and Thermal Characteristics (T_C = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Continuous Reverse Voltage	V _R	30	V
Forward Current	I _F	200	mA
Forward Surge Current, t _p = 10 ms	I _{FSM}	2	A
Power Dissipation T _C = 25°C	P _{tot}	150	mW
Thermal Resistance Junction to Ambient Air	R _{θJA}	650	°C/W
Junction Temperature	T _J	125	°C
Storage Temperature Range	T _S	-55 to +150	°C

Note: (1) Valid provided that electrodes are kept at ambient temperature

Electrical Characteristics (T_J = 25°C unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Breakdown Voltage	BV _R	I _R = 100 μA	30	—	—	V
Leakage Current	I _R	V _R = 30 V	—	—	5.0	μA
Forward Voltage	V _F	I _F = 15 mA	—	320	350	mV
		I _F = 50 mA	—	370	400	
		I _F = 150 mA	—	440	460	
		I _F = 200 mA	—	470	500	
Junction Capacitance	C _{tot}	V _R = 1 V, f = 1.0 MHz	—	25	30	pF